Contributed paper


InGaAs for infrared photodetectors. Physics and technology

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InGaAs is a variable band gap semiconductor with excellent transport and optical properties. This makes it attractive for electronic and optoelectronic devices. One of the most important applications is short wavelength (1–3.6 µm) infrared photodetectors. Such devices are based on multilayer heterostructures with complex band gap and doping profiles. Significant progress in technology of the InGaAs heterostructures has been achieved with MBE and MOCVD growth. We discuss here the status and perspectives of infrared photodetectors based on advanced InGaAs heterostructures.

Keywords: InGaAs photodiodes, optical immersion, resonant cavity, Schottky photodiodes, avalanche photodiodes.

1. Introduction

The ternary variable gap semiconductor InxGa1–xAs is widely used for optoelectronic devices including infrared photodetectors. The devices could be optimised for any wavelength within a spectral range of 0.85–3.6 µm. The lattice parameter of InxGa1–xAs depends on a composition changing from a = 6.06 Å for GaAs (Eg = 1.435 eV) to a = 5.65 Å for InAs (Eg = 0.35 eV). With the exception of In0.53Ga0.47As that is matched to InP, all other x materials grown on InP or GaAs are not lattice matched. InxGa1–xAs layers with sub-critical thickness can be easily defect free grown. Unfortunately, the growth of more thick layers is accompanied by generation of a dislocation and other defects. Efficient absorption of infrared radiation requires layers much thicker than the critical thickness value. Numerous measures have been developed to solve the problem including buffered and lateral growth.

Lattice mismatch presents also significant limitations on the growth of multiple layer heterostructures that are necessary for advanced photodetectors and other optoelectronic devices.

We discuss here physical aspects and practical problems of technology of InxGa1–xAs infrared photodetectors.

2. Conventional photodetectors

2.1. Fundamental limitations to performance of infrared InxGa1–xAs photodetectors

Detectivity D* is the normalized detector signal-to-noise ratio that determines ability of the device to detect weak optical signals

\[ D^* = \frac{R_i (\Delta f)^{1/2}}{I_n}, \]  

where \( R_i \) is the current responsivity, \( A \) is the optical area of a device, \( \Delta f \) is the bandwidth, and \( I_n \) is the noise current.

Detectivity is limited by the noise due to statistical nature of a generation-recombination (g-r) processes. When the thermal processes prevail, the ultimate \( D^* \) of the optimised device operating at near equilibrium conditions can be described as

\[ D^* = 0.31 \frac{\lambda}{hc} \left( \frac{\alpha}{G} \right)^{1/2}, \]  

where \( \lambda \) is the wavelength, \( h \) is the Planck constant, \( c \) is the light velocity, \( \alpha \) is the absorption coefficient, and \( G \) is the thermal generation rate. There are fundamental and technological mechanisms of thermal generation and recombination. The technology related mechanisms (Shockley-Read, generation at surfaces and interfaces, tunnel generation and others) can be eliminated by progress in growth and processing.

Fundamental limits of InxGa1–xAs were discussed in Refs. 1, 2, and 3. Probably, the Auger A1, A7, and AS processes dominate in well-designed device. The role of radiative processes is less clear.

For Auger dominated device

\[ D^* = 0.31 \frac{\lambda}{hc} \left( \frac{\gamma^{1/2} \tau_{A1} \alpha}{n_i} \right)^{1/2}, \]  

where \( n_i \) is the intrinsic concentration, \( \tau_i \) is the recombination time for A1, A7, and AS processes. The coefficient \( \gamma \) is

\[ \gamma = \frac{\tau_{A1} \tau_{A7}}{\tau_{A1}^{1/2} \tau_{A7}^{1/2} + \tau_{AS}^{1/2}}. \]
As shown in Eq. (3), the ultimate detectivity significantly depends on the wavelength for which the detector is optimised. As calculated, the ultimate detectivity changes from $3 \times 10^{13} \text{ cmHz}^{1/2}/\text{W}$ for $\lambda = 2 \mu\text{m}$ to $3 \times 10^{10} \text{ cmHz}^{1/2}/\text{W}$ for $\lambda = 3.4 \mu\text{m}$ (Fig. 1).

The optimised In$_x$Ga$_{1-x}$As photodetectors require appropriate doping of the absorber region (Fig. 2). The doping level depends on the wavelength. The donor doping of $3 \times 10^{15} \text{ cm}^{-3}$ is suitable for $>3 \mu\text{m}$ device while $1 \times 10^{14} \text{ cm}^{-3}$ for $\lambda = 2 \mu\text{m}$. So, pure material may be difficult to grow.

Figure 3 shows an optimised thickness of an absorber. The thickness increases with a wavelength, changing from 5.2 $\mu\text{m}$ to 6.7 $\mu\text{m}$ for 2 $\mu\text{m}$ and 3.4 $\mu\text{m}$ wavelength for a single pass of IR radiation. It should be noted that double pass IR devices need absorbers thinner by a half. A thickness weakly depends on the absorber concentration (Fig. 3).

In addition to the absorber region, practical devices require additional regions that can sense charge carriers photogenerated in the absorber. The p$^+$-i-n$^+$ structure is typically used for a structure for In$_x$Ga$_{1-x}$As photovoltaic device. The performance of such devices can be affected by the additional thermal g-$r$ processes at the p$^+$ and n$^+$ regions, contacts, interfaces, space charge regions, and other noise sources. The common way to eliminate the detrimental processes is the use of sophisticated multilayer heterojunction device structures.

A frequency response of the photovoltaic devices is limited by a transport of the photogenerated charge carriers through the absorber region and by RC time constant. A transport through the absorber region is a combination of diffusion and drift. In$_x$Ga$_{1-x}$As is the material of choice for fast photodiode due to exceptionally large diffusion coefficient of electrons. It should be stressed that the frequency optimised In$_x$Ga$_{1-x}$As devices require lightly p-type doped absorber region for electron mobilities, much larger compared to that of holes.

The diffusion transport times at a room temperature are less than >100 ps for extrinsic p-type = 5-$\mu\text{m}$ thick InAs absorber. Further reduction can be achieved with the thinner absorber. Drift transport in reverse biased devices may reduce the transit time further.

The main limitation of response time typically comes from the RC time constant. For current mode operation, the RC time constant is determined by the junction capacitance and the photodiode series resistance. Reduction of series resistance by almost two orders of magnitude is possible using the structures with heavily doped n-type material for the mesa base, in comparison with p-type base of the same doping. This results in corresponding reduction of the RC time constant.

A very short RC time constant is expected in optically immersed photodiodes with a very small area of an active region. With these improvements, In$_x$Ga$_{1-x}$As photodiodes can be used for gigahertz range detection of IR radiation.

2.2. Optical immersion of infrared photodetectors

An efficient way to reduce the total thermal generation processes is reduction of physical size of the detector in comparison to its apparent optical size. Typically, this is
achieved by optical immersion of the detector to hemi- or hyperhemispherical lens prepared from a high refraction index material [4–6]. This can be implemented using monolithic optical immersion where the lens is formed in transparent detector substrate material.

Table 1 shows the gains due to use of GaAs immersion lens. This material with a large refraction index is transparent in a wide spectral range of (0.9–20 µm) and is frequently used as a substrate for device structures. As we can see, optical immersion significantly improves performance of IR devices.

Table 1. Relative gains due to use of optical immersion to GaAs lenses.

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Hemisphere</th>
<th>Hyper-hemisphere</th>
</tr>
</thead>
<tbody>
<tr>
<td>Linear size</td>
<td>n</td>
<td>n² (~12)</td>
</tr>
<tr>
<td>Area</td>
<td>n² (~3.4)</td>
<td>n⁴ (~12)</td>
</tr>
<tr>
<td>Voltage responsivity</td>
<td>n² (~12)</td>
<td>n⁴ (~134)</td>
</tr>
<tr>
<td>Detectivity</td>
<td>n</td>
<td>n² (~134)</td>
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<tr>
<td>Capacitance</td>
<td>n² (~12)</td>
<td>n⁴ (~134)</td>
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Figures 4 and 5 show GaAs immersion lenses fabricated at the Vigo System S.A. using a monolithic approach. This technology requires relatively thick substrate, in dependence on a detector size. The lenses are prepared with numerically controlled mechano-chemical machining.

Small immersion lenses (< 0.5 mm dia) and lens arrays are fabricated with photolithography-assisted micromachining (Figs. 6 and 7).

2.3. Practical implementation of InAs/GaAs photovoltaic detector

The advanced InAs/GaAs photodetectors have been implemented by Institute of Electron Technology (ITE) in cooperation with VIGO SYSTEM S.A. The detector structures are grown by MBE at ITE while processing and lens fabri-
The quantum efficiency of 60% has been measured, with commercially available InAs devices. The RCE-PD functions largely as a conventional device but is a subject to the effects of the cavity like wavelength selectivity and increase in the optical field. The quantum efficiency $\eta$ for a RCE-PD structure with the lossless mirrors is [7,8]

$$
\eta = \frac{1 + R_2 e^{-\alpha d}}{1 - 2 \sqrt{R_1 R_2} e^{-\alpha d} \cos(2\beta L + \psi_1 + \psi_2) + R_1 R_2 e^{-\alpha d}} \times (1 - R_1)(1 + e^{-\alpha d})
$$

where $R_1$ and $R_2$ are the top and bottom mirror reflectivities, respectively, $\psi_1$ and $\psi_2$ are the phase shifts introduced by the top and bottom mirrors and $L = L_1 + L_2 + d$.

Since the propagation constant $\beta (\beta = 2\pi n/\lambda_0$, where $\lambda_0$ is the vacuum wavelength and $n$ is the refractive index) has wavelength dependence, $\eta$ is the function of the wavelength as well. The calculated changes of wavelength dependency of a quantum efficiency are presented in Fig. 10. The curves correspond to $\alpha d = 0.9, 0.3,$ and 0.05 while $R_2 = 0.9, \alpha d = 0.1$ and $L = 2 \mu m$. The quantum efficiency $\eta$ is enhanced periodically at a resonant wavelength when $2\beta L + \psi_1 + \psi_2 = 2 n \pi (m = 1, 2, 3)$. The spacing of a resonant wavelength is defined as free spectral range FSR. The flat dotted line in Fig. 10 indicates the maximum $\eta$ attainable for conventional photodetector for the same active layer thickness, $\alpha d = 0.1$. The contrast between two types of a detector is clear. Conventional detector operates at a broad-band while RCE detector can be designed for detection specific wavelength.

At the resonance wavelength [7,8]

$$
\eta_p = \frac{1 + R_2 e^{-\alpha d}}{(1 - \sqrt{R_1 R_2} e^{-\alpha d})^2 (1 - R_1)(1 + e^{-\alpha d})}
$$

small gap semiconductor with the absorption coefficient $\alpha$. It is positioned between the two mirror structures at the respective distances from the mirrors $L_1$ and $L_2$. The mirror can be formed by quarter-wave stack of large band gap semiconductors. The RCE-PD functions largely as a conventional device but is a subject to the effects of the cavity like wavelength selectivity and increase in the optical field. The quantum efficiency $\eta$ for a RCE-PD structure with the lossless mirrors is [7,8]

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From Eq. (6), the quantum efficiency at the certain $\alpha d$ value is maximised when

$$R_1 = R_2 e^{-2\alpha d}. \tag{7}$$

Figure 11 shows the maximum $\eta_{\text{max}}$ as a function of $\alpha d$ for various $R_2$ values. To attain the highest $\eta$ near unity $R_2$ is desirable. For conventional detectors, without the cavity effect ($R_2 = 0$), quantum efficiency higher than 90% can be realized only for a thick (> 2 µm) active layer (curve $R_2 = 0$ in Fig. 11). For RCE detector, when $R_2 = 0.99$, the $\eta > 90\%$ can be obtained for < 0.05-µm thick layer ($\alpha = 10^4$ cm$^{-1}$). This fact is very helpful towards improving the high-speed performance of detectors reducing the electronic transit time.

The spatial distribution of the optical field inside the cavity is a specific feature of the cavity. It arises from the standing wave formed by the two propagating waves. A calculated distribution of the optical field is presented in Fig. 12. It follows that $\eta$, which is derived from the power absorbed in the active region, depends on a position of the active region in the optical field. In order to obtain maximum value of the detector efficiency, the active region should be placed in a wave antinode position.

The standing wave effect is conveniently included in the calculation of as an effective absorption coefficient, i.e., $\alpha_{\text{eff}} = \text{SWE} \times \alpha$, where SWE is the standing wave coefficient. The SWE coefficient is an explicit function of the cavity properties [8,9].

Earlier, we confined our consideration of $\eta$ to a normal incidence. The changes of a detector quantum efficiency versus angle incidence are presented in Fig. 13. The calcu-
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lations were performed for different wavelengths and different values of the finesse $F = \text{FSR}/\Delta\lambda_{1/2}$, where $\Delta\lambda_{1/2}$ is half width of a resonant peak). It indicates that $\eta$ is the most sensitive to the angle of incidence in the high $F$ cavity at the shorter $\lambda$ and quantum efficiency degrades by 20% above 10°. The simulations show that RCE detectors cannot work well, even with quite slow optics.

The performance of RCE-PD mainly depends on the realization of a low loss cavity. The mirrors and cavity material must be non-absorbing at the detection wavelength and the mirrors must have high reflectivity. Generally, mirrors can be fabricated as metallic, dielectric, DBR (distributed Bragg reflectors made of semiconducting or dielectric layers) or hybride (DBR + metal).

The active layer material must have a smaller bandgap material than the mirror and cavity materials but it should not be so small that large heterojunction band offsets hinder the extraction of photogenerated carriers. The active layer absorption coefficient should be moderate, i.e., $10^3$ to $10^4$ cm$^{-1}$ for the operation wavelength.

The active layer must have the optimal band structure for the high internal gain avalanche multiplication. Dual heterojunctions can be fabricated as metallic, dielectric, DBR (distributed Bragg reflectors made of semiconducting or dielectric layers) or hybride (DBR + metal).

The active layer material must have a smaller bandgap material than the mirror and cavity materials but it should not be so small that large heterojunction band offsets hinder the extraction of photogenerated carriers. The active layer absorption coefficient should be moderate, i.e., $10^3$ to $10^4$ cm$^{-1}$ for the operation wavelength.

Different material combinations satisfy all of the above requirements. The InGaAs material system for RCE detection is used in two combinations of semiconductors, AlGaAs/GaAs/InGaAs and InP/InGaAs/InGaAsP.

Application of InGaAs as the active material allows for extension device operation spectrum to the wavelength longer than 900 nm. This ternary compound containing small amount of In can be grown on GaAs substrate. In this case AlAs and GaAs, having good refractive index contrast, can be used for construction of the mirrors of the resonant cavity with nearly unit reflectivity with about twenty period quarter wave superlattice.

In$_x$Ga$_{1-x}$As containing higher amount of indium ($x = 0.5$) is usually grown on InP substrate. In$_{0.53}$Ga$_{0.47}$As and In$_{0.52}$Al$_{0.48}$As lattice matched to InP have rather poor refractive index contrast and increased number of periods ($>35$) are required to achieve nearly unit reflectivity of the mirror. For the detectors operating at $1.3$ to $1.55$ µm wavelength range, quaternary compounds like InGaAlAs and InGaAsP lattice matched to InP are more suitable for mirror formation.

3.2. Practical implementation of RCE-PDs

To the date, InGaAs ternary compound has been the most commonly studied ternary compound for RCE detection because of the easiness with which GaAs and InP based heterostructures can be grown by molecular beam epitaxy (MBE) and metalorganic chemical vapour deposition (MOCVD) [10]. The capabilities have been demonstrated in many practical photodetectors.

3.2.1. RCE-Schottky photodetectors

The AlGaAs/GaAs/InGaAs based RCE-Schottky photodetector, presented in Ref. 11, operated at 895 nm.

A schematic representation of this structure is shown in Fig. 14. The device structure was grown on a GaAs substrate by MBE. The cavity is formed by 15 pairs AlAs/GaAs DBR bottom reflector and a semi transparent Au contact on the top. The InGaAs absorption layer has an In mole fraction less than 10% and both heterojunctions are linearly graded for 25 nm to avoid carrier trapping. The position of the absorption layer in the depletion region is optimised to yield minimum transit time for electrons and holes [11]. The device was fabricated with mesa isolation. To reduce the parasitic capacitance of the photodetector, the Schottky metal was connected to the contact pads with an Au air-bridge. A 200 nm Si$_3$N$_4$ coating on the top was used.

The optimised RCE-Schottky photodiode has a 3 dB bandwidth of $\approx 100$ GHz and bandwidth-efficiency product $> 70$ GHz.

Using the indium tin oxide (ITO) for the Schottky diode solves the problems of optical losses and scattering caused by the Schottky metal. For the RCE-ITO-Schottky diode fabricated by Biyikli et al. with an area of $5 \times 5 \mu$m, the bandwidth was 60 GHz while the quantum efficiency was 75% for a reverse voltage of 4 V [12]. This results in a bandwidth-efficiency product of 45 GHz.

3.2.2. RCE avalanche PD

The internal gain of avalanche photodiodes (APDs) provides substantial improvement in signal-to-noise characteristics compared to other types of PDs. The APD structure that has been widely deployed is the separate absorption and multiplication region (SAM) APD. It consists of a wide-bandgap multiplication region and a narrow-bandgap absorbing layer separated by a transition region that reduces the accumulation of a charge at the interface between the multiplication and absorption regions which improves the low-gain bandwidth.

In order to reduce the transit time and thus improve the frequency response at low gains, the APD layers are incorporated into a resonant-cavity structure [13,14]. The device...
structure is shown in Fig. 15. Starting from a semi-insulating InP substrate, the bottom mirror, which consisted of 30 \( \lambda / 4 \) pairs of \( n^+\text{In}_{0.53}\text{Ga}_{0.47}\text{As}/n\text{In}_{0.52}\text{Al}_{0.48}\text{As} \), was grown by MBE. After the growth of the thin undoped \( \text{In}_{0.52}\text{Al}_{0.48}\text{As} \) multiplication region, a p-type \( \text{In}_{0.52}\text{Al}_{0.48}\text{As} \) charge layer was inserted to ensure that the electric field in the adjacent absorption region would be less than \( 1 \times 10^5 \) V/cm. This was followed by the 60 nm-thick \( \text{In}_{0.53}\text{Ga}_{0.47}\text{As} \) absorption layer. Finally, an undoped \( \text{In}_{0.52}\text{Al}_{0.48}\text{As} \) spacer and a \( p^+\text{In}_{0.52}\text{Al}_{0.48}\text{As} \) top layer were grown. To fabricate a high-speed device, first a Ti-Pt-Au contact metal ring was deposited and a mesa with the diameter of 14 \( \mu \text{m} \) was formed by chemical etching.

Due to the resonant-cavity scheme, these APDs operating at 1.55 \( \mu \text{m} \) exhibited high external quantum efficiency 70\% and a high unity-gain bandwidth of 24 GHz. Utilizing the excellent noise characteristics of a thin InAlAs multiplication region, a record value of a gain-bandwidth product of 290 GHz was achieved.

### 3.2.3. RCE p-i-n PD

The first RCE p-i-n was reported by Dentai et al. who studied an \( \text{InGaAs/InGaAsP/InP} \) structure designed to operate near 1.55 \( \mu \text{m} \) [15]. A quantum efficiency of 82\% was achieved using a 200 Å InGaAs absorbing layer with \( R_1 = 0.7 \) and \( R_2 = 0.95 \).

RCE p-i-n PDs with a periodic absorber structure were demonstrated by Huang et al. to detect 870-nm wavelength [16]. Figure 16(a) depicts the schematic structure of a typical RC photodiode with a single absorbing layer placed in a wave antinode position. In order to improve quantum efficiency of RCE p-i-n PD, it was proposed to use a triple layer as the active medium. The thickness of the spacer layers were chosen so that the three absorbing layers are located at the antinodes of the standing wave optical field in the cavity [Fig. 16(b)]. The investigated devices, shown schematically in Fig. 17(a), were grown by MBE on \( n^+\text{GaAs} \) substrate. Thirteen period AlAs/GaAs quarter-wave stacks formed bottom mirror with the reflectivity about 90\% at the centre wavelength 900 nm. The three \( \text{In}_{0.05}\text{Ga}_{0.95}\text{As} \) active layers with each layer of the thickness 40 nm were sandwiched between GaAs layers. The top mirror with 30\% reflectivity was formed by air and semiconductor interface.

The peak quantum efficiency of the triple-layer resonant-periodic-absorber photodiode was 65\% [see Fig. 17(b)]. An enhancement of 30\% has been achieved by a periodic absorber structure as compared to a standard RCE photodiode with a single absorbing layer of the same total thickness.
In order to simplify InGaAs/InP RCE p-i-n PD structure different types of reflectors can be used. Schematic structure of the RCE device utilizing hybrid reflector and semiconducting DBR is presented in Table 2.

The device is illuminated from the bottom. A detector is grown on SI-InP substrate. The bottom DBR is made of In$_{0.52}$Al$_{0.48}$As and In$_{0.53}$Ga$_{0.32}$Al$_{0.15}$As alternative layers. The resonant cavity is formed by 78 nm thick In$_{0.53}$Ga$_{0.47}$As absorption layer, two In$_{0.52}$Al$_{0.48}$As spacer layers together with two contact In$_{0.52}$Al$_{0.48}$As layers. Top mirror consists of the dielectric DBR and Al layer. The detector structure was optimised using transfer matrix method. The calculations were performed for the device structure operating at $\lambda = 1548$ nm. The changes of absorption of 78-nm thick active layer versus amount of In$_{0.52}$Al$_{0.48}$As/In$_{0.53}$Ga$_{0.32}$Al$_{0.15}$As pairs (bottom reflector) and Si$_3$N$_4$/SiO$_2$ pairs in top reflector are presented in Fig. 18. It has been found that more than 90% absorption of the active layer is obtained when 9 pairs in bottom reflector and 3 pairs in top reflector are used (Fig. 19).

This result is very important, because relatively small number of pairs is required for mirror formation. Additionally, very thin active layer results in subpicosecond transit time of the RCE p-i-n PD. High quantum efficiency for a narrow absorption line centred at 1548 nm can be obtained. The structure can be easily fabricated by MBE.
InGaAs ternary compound is widely used for detection of short wavelength infrared radiation. Modern InGaAs detectors are fabricated by means of MBE and MOCVD technologies and advanced processing. It allows for production of discrete photodiodes, arrays, as well as optical integrated devices.

Conventional detectors can operate at a wide spectral range whereas RCE PDs are capable to detect narrow resonant wavelength only. The increased optical field allows RCE PD to be thinner and therefore faster than conventional one. RCE PDs exhibit high bandwidth and high external quantum efficiency as well.

The refractive microlenses can be used as optical concentrators for conventional photodetectors. They allow for improvement in performance and speed of response of devices. In the case of RCE PDs, strong degradation of quantum efficiency for off-normal angle incident radiation is observed.

Acknowledgements

The authors would like to thank Dr Jan Muszalski for modelling and optimisation of InGaAs/InP RCE photodiodes. This work was partially supported by the Polish Committee for Scientific Research under grant No. 4 T11B 015 25.

References
